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TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

TCR2EN series

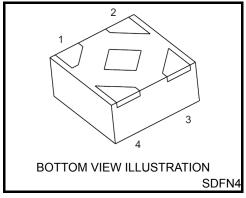
200 mA CMOS Low Drop-Out Regulator in ultra small package

The TCR2EN series are CMOS general-purpose single-output voltage regulators with an on/off control input, featuring low dropout voltage, low quiescent bias current and fast load transient response.

These voltage regulators are available in fixed output voltages between 1.0 V and 3.6 V and capable of driving up to 200 mA. They feature overcurrent protection and an Auto-discharge function.

The TCR2EN series is offered in the ultra small plastic mold package SDFN4 (0.8 mm x 0.8 mm x 0.38 mm). It has a low dropout voltage of 160 mV (2.5 V output, I_{OUT} = 150 mA) with low output noise voltage of 35 μ V_{rms} (2.5 V output) and a load transient response of only \angle V_{OUT} = ±55 mV (I_{OUT} = 1 mA⇔150 mA, C_{OUT} = 1.0 μ F).

As small ceramic input and output capacitors can be used with the TCR2EN series, these devices are ideal for portable applications that require high-density board assembly such as cellular phones.



Weight: 0.6 mg (typ.)

Features

- Low Drop-Out voltage
 - $V_{IN}-V_{OUT}$ = 160 mV (typ.) at 2.5 V-output, I_{OUT} = 150 mA
 - $V_{IN}-V_{OUT}$ = 210 mV (typ.) at 1.8 V-output, I_{OUT} = 150 mA
 - V_{IN}-V_{OUT} = 360 mV (typ.) at 1.2 V-output, I_{OUT} = 150 mA
 - V_{IN}-V_{OUT} = 490 mV (typ.) at 1.0 V-output, I_{OUT} = 150 mA
- Low output noise voltage
 - V_{NO} = 35 μV_{rms} (typ.) at 2.5 V-output, I_{OUT} = 10 mA, 10 Hz < f < 100 kHz
 - V_{NO} = 30 μ V_{rms} (typ.) at 1.8 V-output, I_{OUT} = 10 mA, 10 Hz < f < 100 kHz
 - V_{NO} = 23 μ V_{rms} (typ.) at 1.2 V-output, I_{OUT} = 10 mA, 10 Hz < f < 100 kHz
 - V_{NO} = 18 μ V_{rms} (typ.) at 1.0 V-output, I_{OUT} = 10 mA, 10 Hz < f < 100 kHz
- Fast load transient response ($\angle V_{OUT}$ = ±55 mV (typ.) at I_{OUT} = 1 mA \Leftrightarrow 150 mA, C_{OUT} =1.0 μ F)
- Low quiescent bias current ($I_B = 35 \ \mu A (typ.) at I_{OUT} = 0 \ mA$)
- High ripple rejection (R.R = 73 dB (typ.) at 2.5 V-output, I_{OUT} = 10 mA, f = 1 kHz)
- Wide range Output Voltage line up (V_{OUT} = 1.0 to 3.6 V)
- High V_{OUT} accuracy $\pm 1.0\%$ (1.8 V $\leq V_{OUT}$)
- Overcurrent protection
- Auto-discharge
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used (C_{IN} = 0.1µF, C_{OUT} =1.0 µF)
- Ultra Small package SDFN4 (0.8 mm x 0.8 mm x 0.38 mm)

Absolute Maximum Ratings (Ta = 25°C)

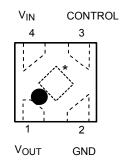
Characteristics	Symbol	Rating	Unit
Input voltage	V _{IN}	6.0	V
Control voltage	V _{CT}	-0.3 to 6.0	V
Output voltage	V _{OUT}	-0.3 to V _{IN} + 0.3	V
Output current	I _{OUT}	200	mA
Power dissipation	PD	300 (Note1)	mW
Operation temperature range	T _{opr}	-40 to 85	°C
Junction temperature	Тј	150	°C
Storage temperature range	T _{stg}	–55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Rating at mounting on a board Glass epoxy(FR4) board dimension: 40mm x 40mm x 1.6mm, both sides of board Metal pattern ratio: a surface approximately 50%, the reverse side approximately 50% Through hole: diameter 0.5mm x 24

Pin Assignment (top view)



*Center electrode should be connected to GND or Open

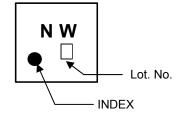
List of Products Number, Output voltage and Marking

Product No.	Output voltage(V) (typ.)	Marking	Product No.	Output voltage(V) (typ.)	Marking
TCR2EN10	1.0	NJ	TCR2EN27	2.7	NO
TCR2EN105	1.05	NU	TCR2EN28	2.8	NP
TCR2EN11	1.1	N2	TCR2EN285	2.85	N7
TCR2EN115	1.15	NC	TCR2EN29	2.9	NR
TCR2EN12	1.2	N3	TCR2EN30	3.0	NS
TCR2EN125	1.25	NQ	TCR2EN31	3.1	NT
TCR2EN13	1.3	N4	TCR2EN32	3.2	NV
TCR2EN15	1.5	NA	TCR2EN33	3.3	NW
TCR2EN18	1.8	NE	TCR2EN34	3.4	NX
TCR2EN19	1.9	NF	TCR2EN35	3.5	NY
TCR2EN21	2.1	NH	TCR2EN36	3.6	NZ
TCR2EN25	2.5	NM			

Please ask your local retailer about the devices with other output voltages.

Marking (top view)

Example: TCR2EN33 (3.3 V output)



Electrical Characteristics

(Unless otherwise specified,

$V_{IN}=V_{OUT}+1~V,~I_{OUT}=50~mA,~C_{IN}=0.1~\mu\text{F},~C_{OUT}=1.0~\mu\text{F},~T_{j}=25^{\circ}\text{C})$

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Output voltage accuracy	Vour	I _{OUT} = 50 mA (Note2)	V _{OUT} < 1.8 V	-18		+18	mV
	V _{OUT}		1.8 V ≤ V _{OUT}	-1.0		+1.0	%
Input voltage	V _{IN}	I _{OUT} = 1 mA		1.5	_	5.5	V
Line regulation	Reg·line	V _{OUT} + 0.5 V ≤ V _{IN} ≤ 5.5 V, I _{OUT} = 1 mA		—	1	15	mV
Load regulation	Reg·load	1 mA ≤ I _{OUT} ≤ 150 mA		—	15	30	mV
Quiescent current	Ι _Β	I _{OUT} = 0 mA			35	60	μA
Stand-by current	IB (OFF)	V _{CT} = 0 V			0.1	1.0	μA
Drop-out voltage	VIN-VOUT	I _{OUT} = 150 mA (Note 3)			160	210	mV
Temperature coefficient	T _{CVO}	$-40^{\circ}C \le T_{opr} \le 85^{\circ}C$		—	75		ppm/°C
Output noise voltage	V _{NO}	V _{IN} = V _{OUT} + 1 V, I _{OUT} = 10 mA, 10 Hz ≤ f ≤ 100 kHz, Ta = 25°C (Note 3)		_	35	_	μV _{rms}
Ripple rejection ratio	R.R.	$\label{eq:VIN} \begin{split} V_{IN} &= V_{OUT} + 1 \ V, \ I_{OUT} = 10 \ \text{mA}, \\ f &= 1 \ \text{kHz}, \ V_{Ripple} = 500 \ \text{mV}_{p\text{-}p}, \\ Ta &= 25^{\circ}\text{C} (\text{Note 3}) \end{split}$		_	73	_	dB
Load transient response	⊿Vout	I _{OUT} = 1mA⇔150mA, C _{OUT} = 1.0 μF			±55	_	mV
Control voltage (ON)	V _{CT (ON)}	—		1.0		5.5	V
Control voltage (OFF)	V _{CT (OFF)}	—		0		0.4	V

Note 2: Stable state with fixed $I_{\mbox{\scriptsize OUT}}$ condition

Note 3: The 2.5 V output product

Drop-out voltage for different output voltages

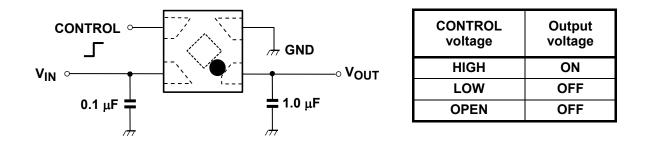
(I_{OUT} = 150 mA, C_{IN} = 0.1 μ F, C_{OUT} = 1.0 μ F, T_j = 25°C)

Output voltages	Symbol	Min	Тур.	Max	Unit
1.0 V, 1.05 V		_	490	750	
1.1 V, 1.15 V		_	420	650	
1.2 V, 1.25 V	V _{IN} – V _{OUT}	_	360	550	
1.3 V		_	330	450	
1.4 V		_	290	400	mV
1.5 V ≤ V _{OUT} < 1.8 V		_	270	370	
1.8 V ≤ V _{OUT} < 2.5 V		_	210	290	
2.5 V ≤ V _{OUT} < 3.0 V		_	160	210	
3.0 V ≤ V _{OUT} ≤ 3.6 V		_	130	180	

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Application Note

1. Recommended Application Circuit



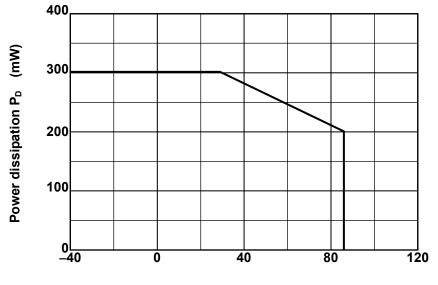
The figure above shows the recommended configuration for using a Low-Dropout regulator. Insert a capacitor at V_{OUT} and V_{IN} pins for stable input/output operation. (Ceramic capacitors can be used).

2. Power Dissipation

Power dissipation is measured on the board condition shown below.

[The Board Condition]

Board material: Glass epoxy(FR4) Board dimension: 40mm x 40mm (both sides of board), t=1.6mm Metal pattern ratio: a surface approximately 50%, the reverse side approximately 50% Through hole: diameter 0.5mm x 24



Ambient temperature Ta (°C)

Usage Considerations

Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommend the ESR of ceramic capacitor is under 10Ω .

Mounting

The long distance between IC and output capacitor might affect phase assurance by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

Permissible Loss

Please have enough design patterns for expected maximum permissible loss. And under consideration of surrounding temperature, input voltage, and output current etc, we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 percent.

• Overcurrent Protection Circuit

Overcurrent protection circuit is designed in these products, but this does not assure for the suppression of uprising device operation. If output pins and GND pins are shorted out, these products might be break down.

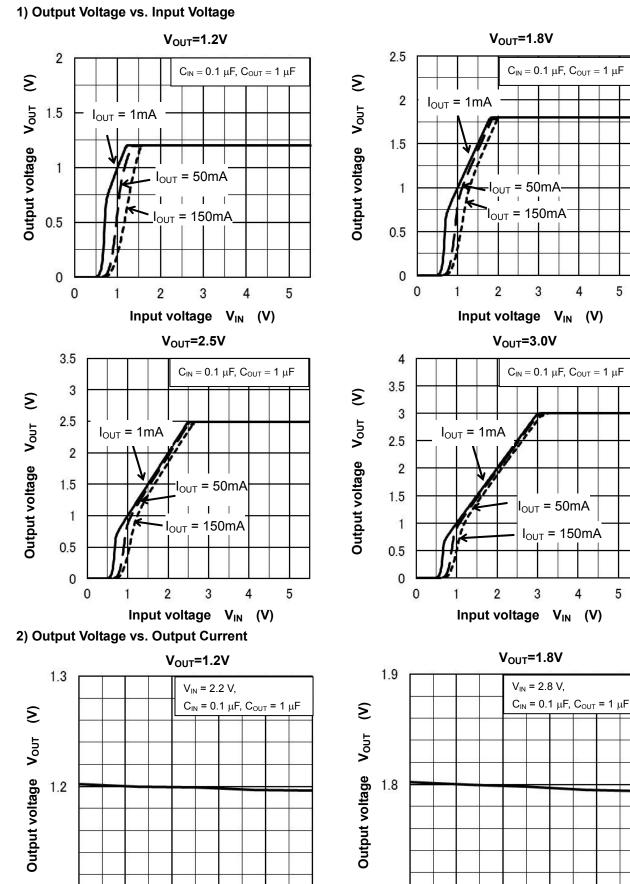
In use of these products, please read through and understand dissipation idea for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommend inserting failsafe system into the design.

1.1

Output current IOUT

(mA)

Representative Typical Characteristics



1.7

Output current I_{OUT} (mA)

 C_{IN} = 0.1 μ F, C_{OUT} = 1 μ F

V_{OUT}=3.0V

V_{IN} = 4.0 V,

3.1

ε

Output voltage Vour

3

2.9

0

40

80

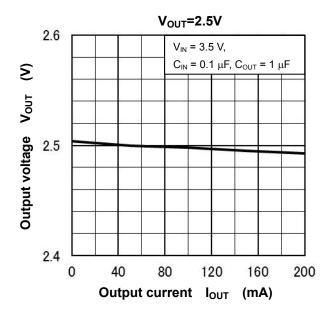
Output current IOUT

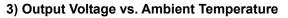
120

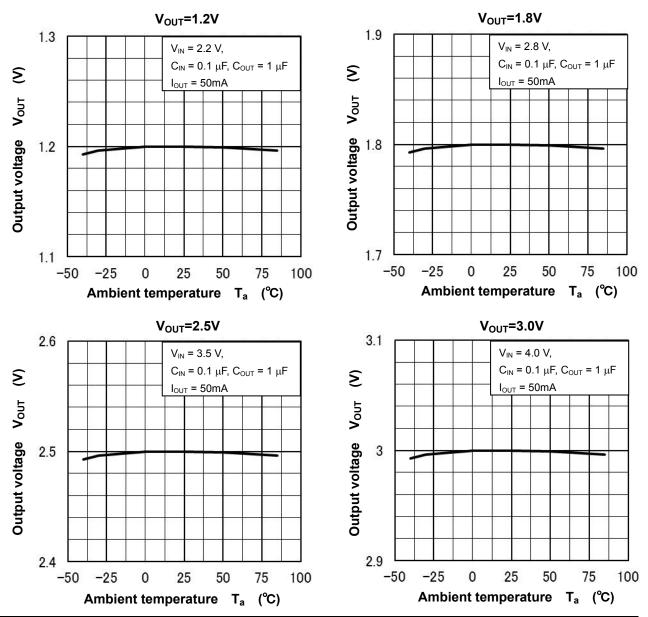
160

(mA)

200



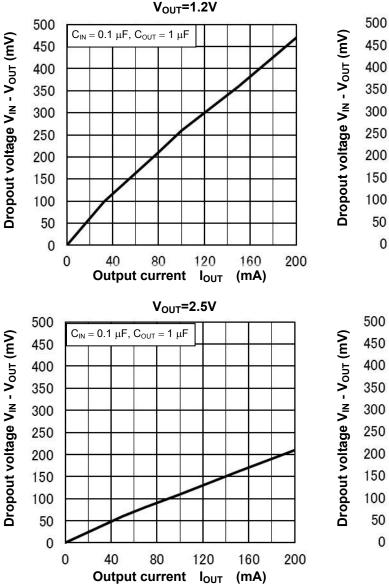




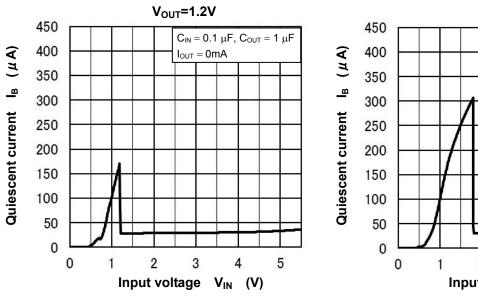
V_{OUT}=1.8V

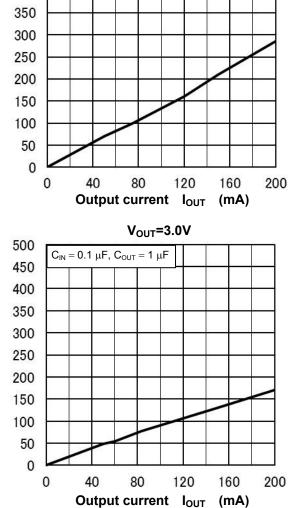
 $C_{IN} = 0.1 \ \mu F, \ C_{OUT} = 1 \ \mu F$

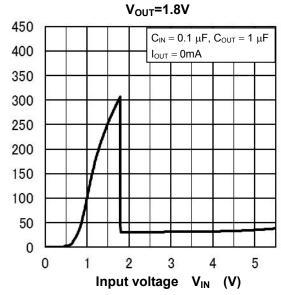
4) Dropout Voltage vs. Output Current

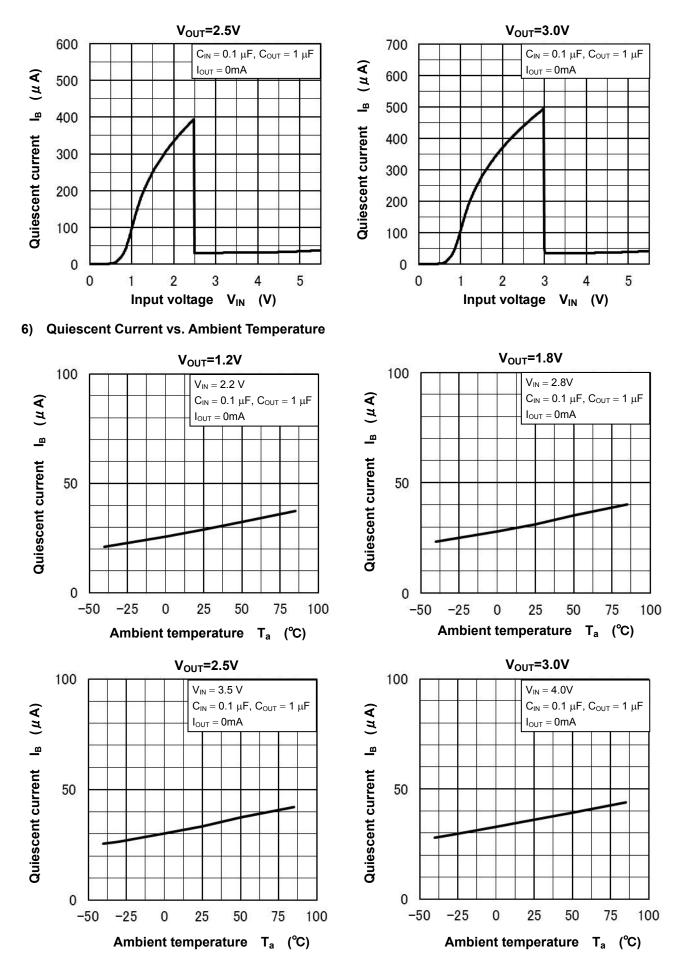


5) Quiescent Current vs. Input Voltage

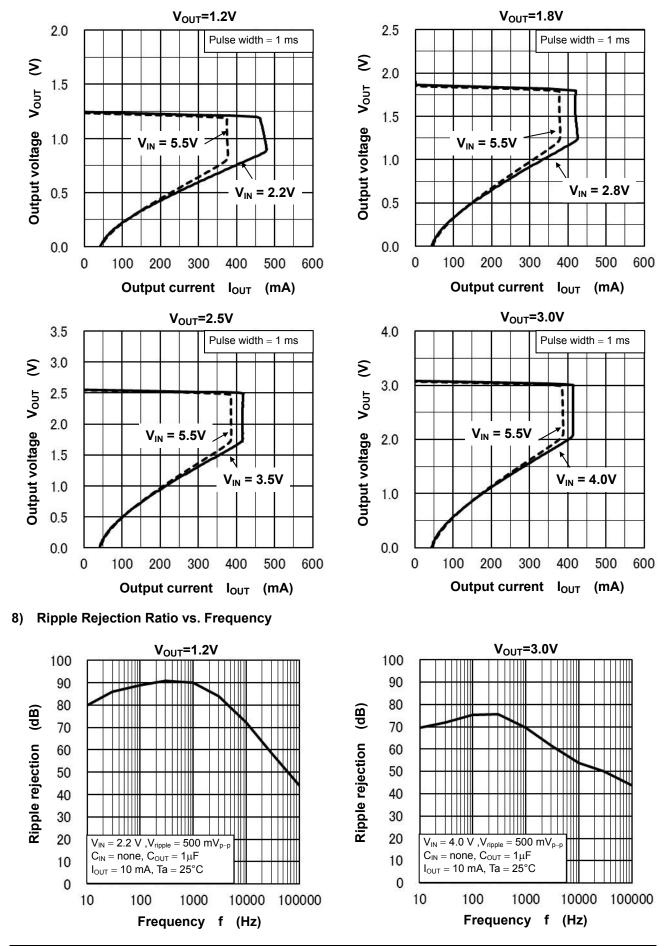




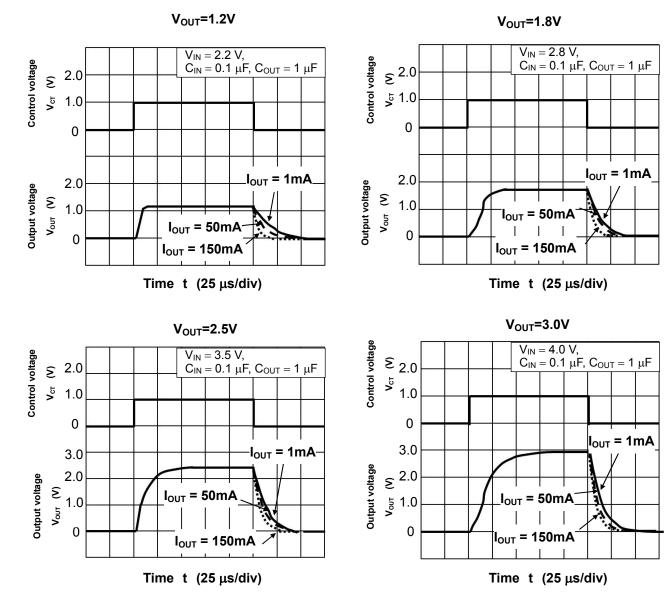




7) Output Voltage vs. Output Current

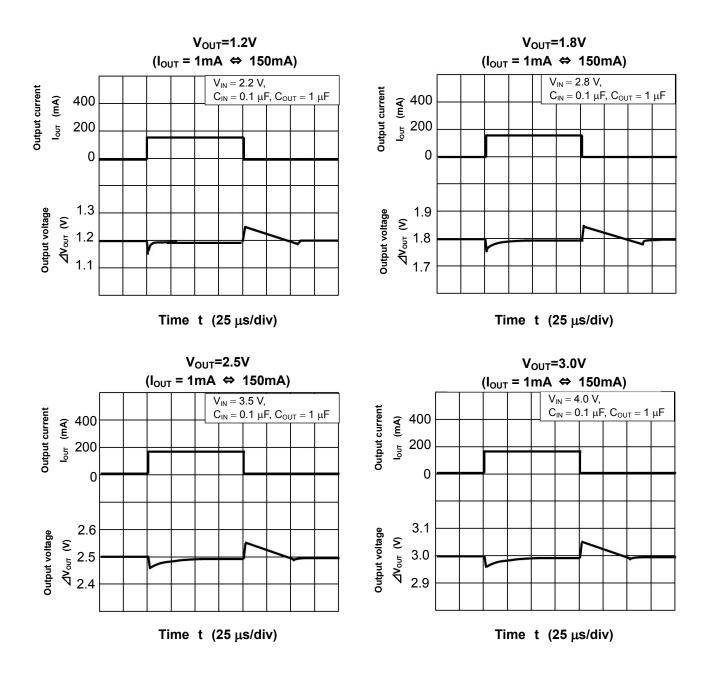


9) Control Transient Response



10) Load Transient Response

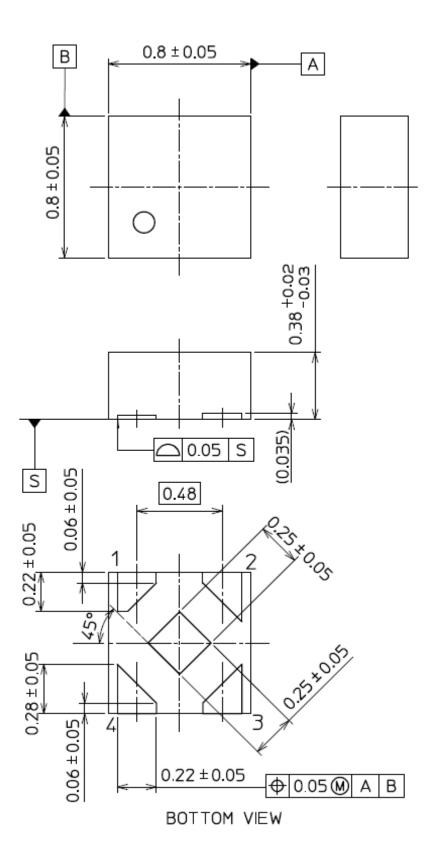
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Package Dimensions

SDFN4

Unit:mm



0.04 mm (typ.) unevenness exists along the edges of the back electrode to increase shear after soldering.

Weight : 0.6 mg (typ.)

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